



## GaAs MMIC DOUBLE-BALANCED MIXER, 2 - 18 GHz

### Typical Application

The HMC1048LC3B is ideal for:

- Ka-band Transponders
- Point-to-Multi-Point Radios & VSAT
- Test Equipment & Sensors
- Military End-Use

### Features

Passive: No DC Bias Required

High Input IP3: 23 dBm

LO/RF Isolation: 38 dB

LO/IF Isolation: 28 dB

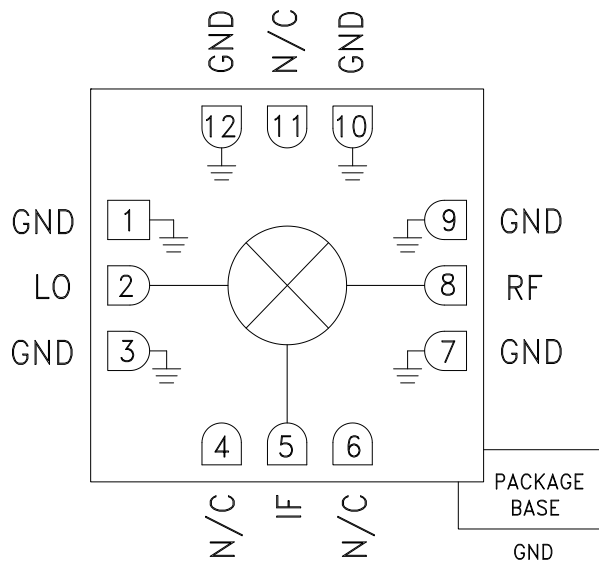
RF/IF Isolation: 15 dB

IF Bandwidth: DC - 4 GHz

Downconverter Applications

12 Lead Ceramic 3 x 3 mm SMT Package: 9 mm<sup>2</sup>

### Functional Diagram



### General Description

The HMC1048LC3B is a general purpose double balanced mixer that can be used as a downconverter with DC to 4 GHz at the IF port and 2 to 18 GHz at the RF port. This mixer requires no external components or matching circuitry. The HMC1048LC3B provides excellent LO/RF, LO/IF and RF/IF isolation. The mixer operates with LO drive levels from +9 dBm to +17 dBm. The HMC1048LC3B eliminates the need for wire bonding and allows the use of surface mount manufacturing techniques.

### Electrical Specifications, $T_A = +25\text{ }^\circ\text{C}$ , Downconverter, IF = 100 MHz, LO = +13 dBm<sup>[1]</sup>

Parameter	Min.	Typ.	Max.	Min.	Typ.	Max.	Units
Frequency Range, RF & LO	2 - 12		12 - 18				GHz
Frequency Range, IF	DC - 4		DC - 4				GHz
Conversion Loss		9	12		11	13	dB
LO to RF Isolation <sup>[2]</sup>	28	38		28	35		dB
LO to IF Isolation <sup>[2]</sup>	15	20		18	28		dB
RF to IF Isolation	8	15		6	12		dB
IP3 (Input)		20			23		dBm
1 dB Gain Compression (Input)		10			13		dBm

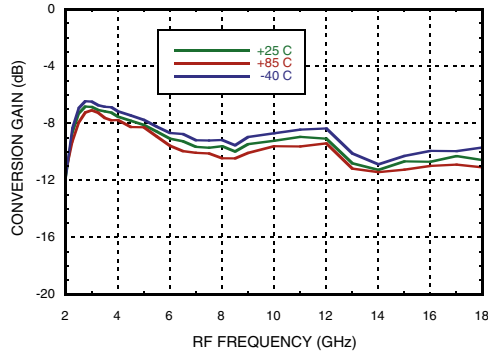
[1] Unless otherwise noted all measurements performed as an Downconverter.

[2] Fixed IF = 100 MHz.

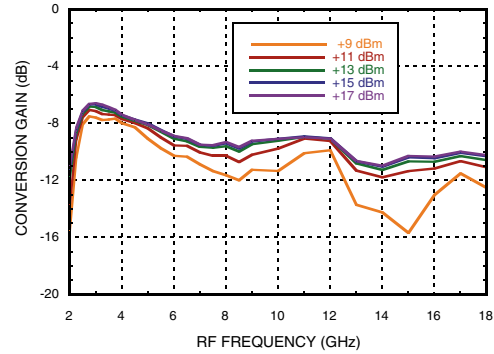


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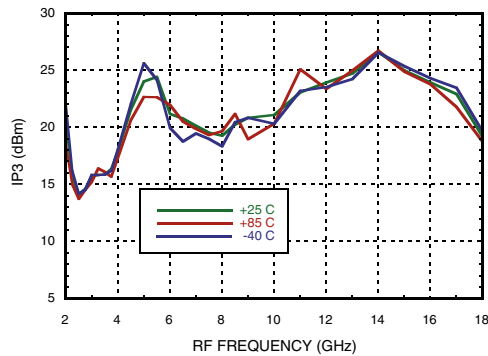
**Conversion Gain vs. Temperature, IF = 100 MHz, LO = 13 dBm**



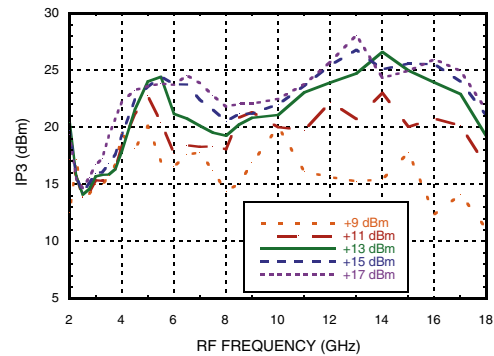
**Conversion Gain vs. LO Power, IF = 100 MHz**



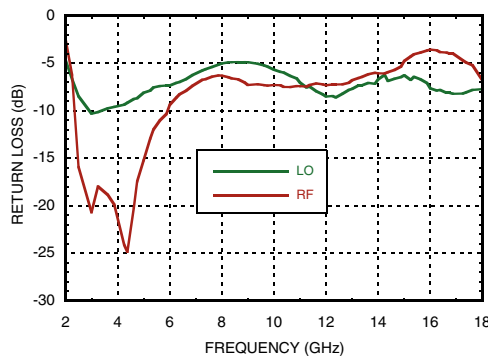
**Input IP3 vs. Temperature, IF = 100 MHz, LO = 13 dBm**



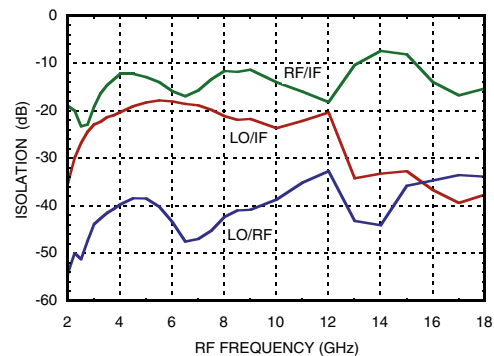
**Input IP3 vs. LO Power, IF = 100 MHz**



**RF and LO Return Loss**



**Isolation**



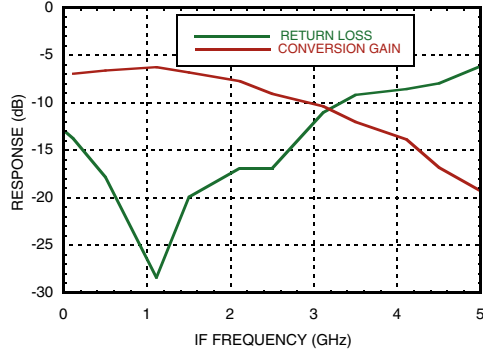
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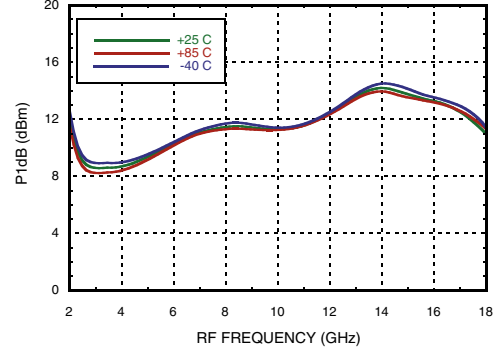


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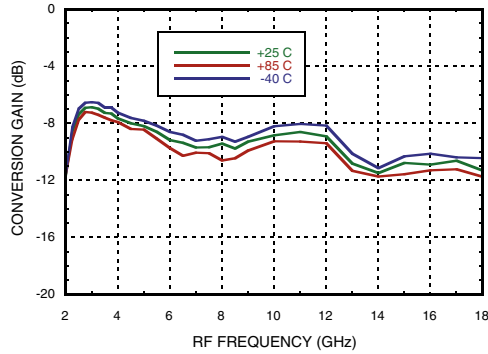
**IF Bandwidth @ LO = 13 dBm,  
LO = 2.4 GHz**



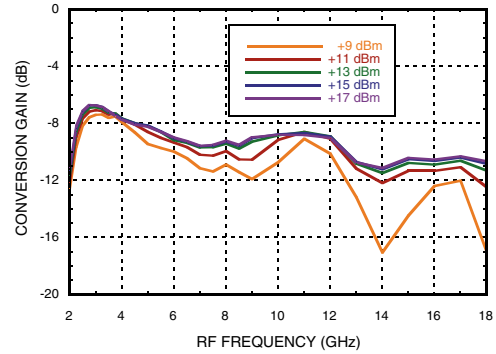
**Input P1dB vs. Temperature  
IF = 100 MHz, LO = 13 dBm**



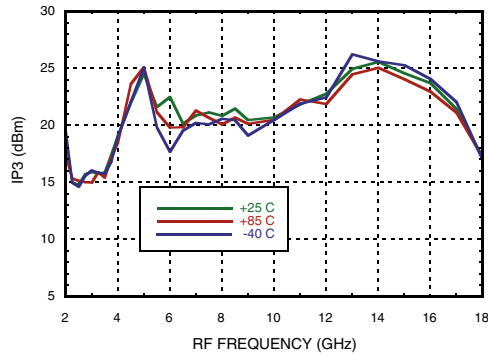
**Conversion Gain vs. Temperature,  
IF = 500 MHz, LO = 13 dBm**



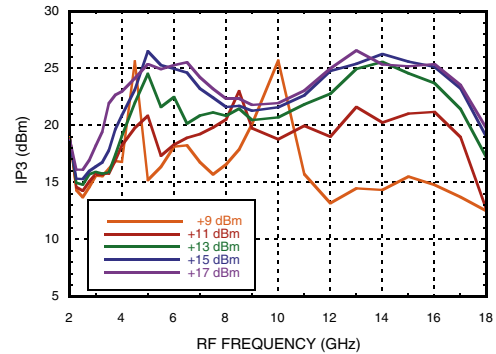
**Conversion Gain vs. LO Power,  
IF = 500 MHz**



**Input IP3 vs. Temperature,  
IF = 500 MHz, LO = 13 dBm**



**Input IP3 vs. LO Power  
IF = 500 MHz**



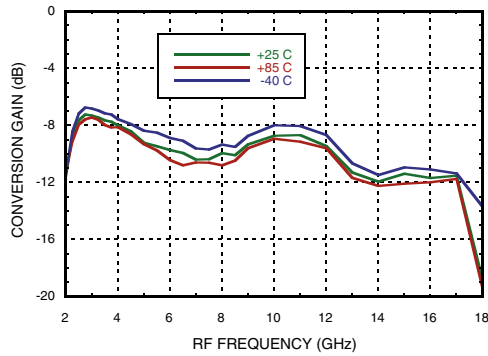
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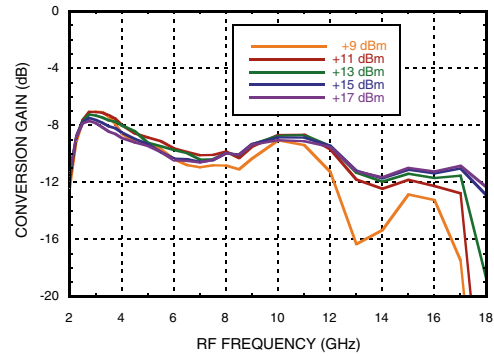


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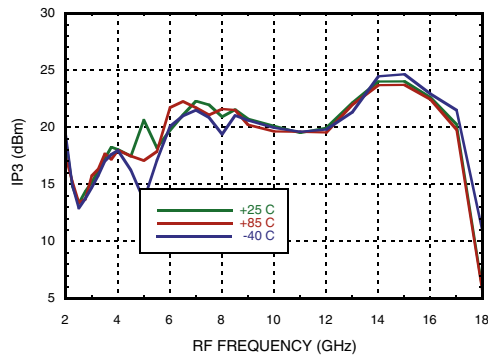
**Conversion Gain vs. Temperature,  
IF = 1500 MHz, LO = 13 dBm**



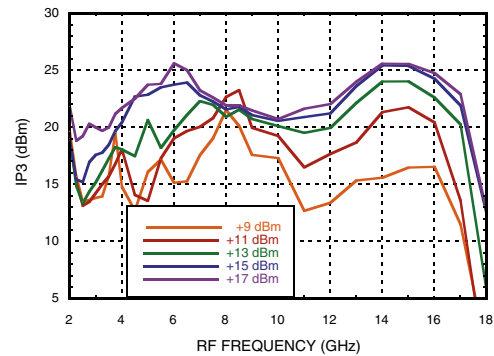
**Conversion Gain vs. LO Power,  
IF = 1500 MHz**



**Input IP3 vs. Temperature,  
IF = 1500 MHz, LO = 13 dBm**



**Input IP3 vs. LO Power,  
IF = 1500 MHz**





## GaAs MMIC DOUBLE-BALANCED MIXER, 2 - 18 GHz

### MxN Spurious Outputs, Downconverter

mRF	nLO				
	0	1	2	3	4
0	x	-0.5	26.8	-2.4	29.6
1	7.5	0	16.2	18.8	28.5
2	62.2	55.2	55.5	48.1	58.3
3	65	63.7	63.6	67.7	67.3
4	63.5	67.1	65.3	68.9	69.3

RF = 2 GHz @ -10 dBm  
 LO = 2.1 GHz @ +13 dBm  
 All values in dBc below IF power level

### MxN Spurious Outputs, Upconverter

mIF	nLO				
	0	1	2	3	4
0	x	-10.3	16.6	15.2	29.5
1	5.4	0	26.7	24	36.3
2	55.6	39.6	52.2	39.9	52
3	65.4	60.1	57.7	63.8	64.5
4	64.6	66.7	67.1	69.8	71.7

RF = 4 GHz @ -10 dBm  
 LO = 4.1 GHz @ +13 dBm  
 All values in dBc below RF power level

### Harmonics of LO

LO Freq. (GHz)	nLO Spur at RF Port			
	1	2	3	4
2	60.76	45.98	58.15	56.06
4	39.86	31.63	49.77	43.87
6	43.29	31.08	51.66	58.58
10	39.12	31.05	62.34	64.12
12	32.53	42.18	32.52	70.08
14	45.01	53.44	41.58	NA

LO = + 13 dBm  
 Values in dBc below LO level measured at RF Port.



## GaAs MMIC DOUBLE-BALANCED MIXER, 2 - 18 GHz

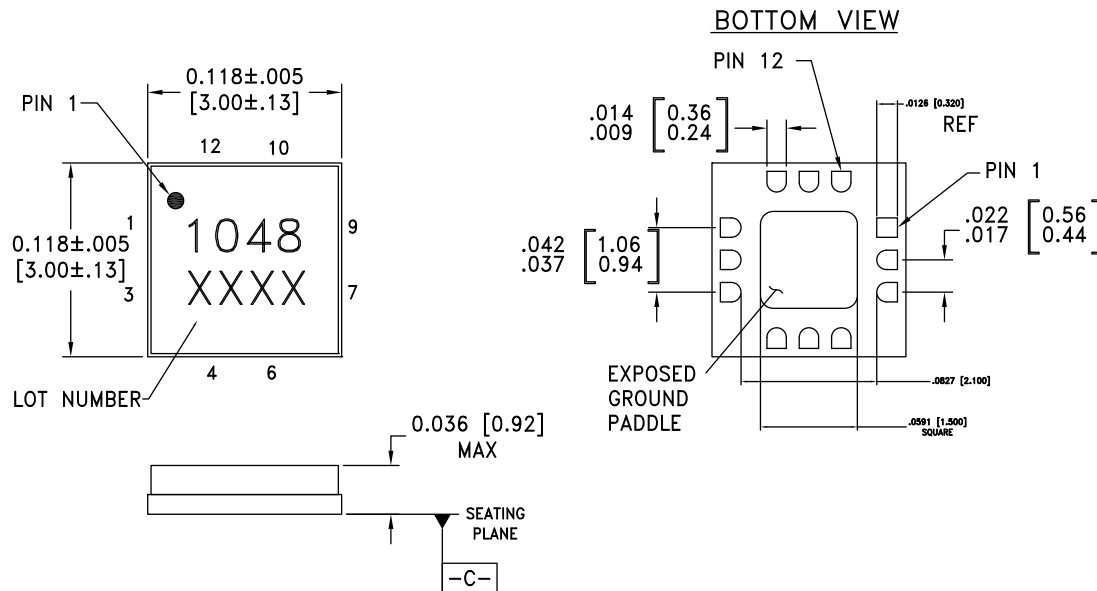
### Absolute Maximum Ratings

RF / IF Input( LO = +18 dBm)	+15.5 dBm
LO Drive	+20 dBm
Max Junction Temperature @ 85°C w/ 19 dBm	116 °C
Continuous Pdiss (T = 85 °C) (derate 2.5 mW/°C above 85 °C)	165 mW
Thermal Resistance (R <sub>TH</sub> ) (junction to package bottom)	392 °C/W
Storage Temperature	-65 to +150 °C
Operating Temperature	-55 to +85 °C
ESD Sensitivity (HBM)	Class 1A



ELECTROSTATIC SENSITIVE DEVICE  
OBSERVE HANDLING PRECAUTIONS

### Outline Drawing



NOTES:

1. PACKAGE BODY MATERIAL: ALUMINA
2. LEAD AND GROUND PADDLE PLATING: 30-80 MICROINCHES GOLD OVER 50 MICROINCHES MINIMUM NICKEL.
3. DIMENSIONS ARE IN INCHES [MILLIMETERS].
4. LEAD SPACING TOLERANCE IS NON-CUMULATIVE.
5. CHARACTERS TO BE BLACK INK MARKED WITH .018"MIN to .030"MAX HEIGHT REQUIREMENTS. UTILIZE MAXIMUM CHARACTER HEIGHT BASED ON LID DIMENSIONS AND BEST FIT. LOCATE APPROX. AS SHOWN.
6. PACKAGE WARP SHALL NOT EXCEED 0.05mm DATUM -C-
7. ALL GROUND LEADS AND GROUND PADDLE MUST BE SOLDERED TO PCB RF GROUND.

### Package Information

Part Number	Package Body Material	Lead Finish	MSL Rating	Package Marking <sup>[2]</sup>
HMC1048LC3B	Alumina, White	Gold over Nickel	MSL3 <sup>[1]</sup>	H1048 XXXX

[1] Max peak reflow temperature of 260 °C

[2] 4-Digit lot number XXXX



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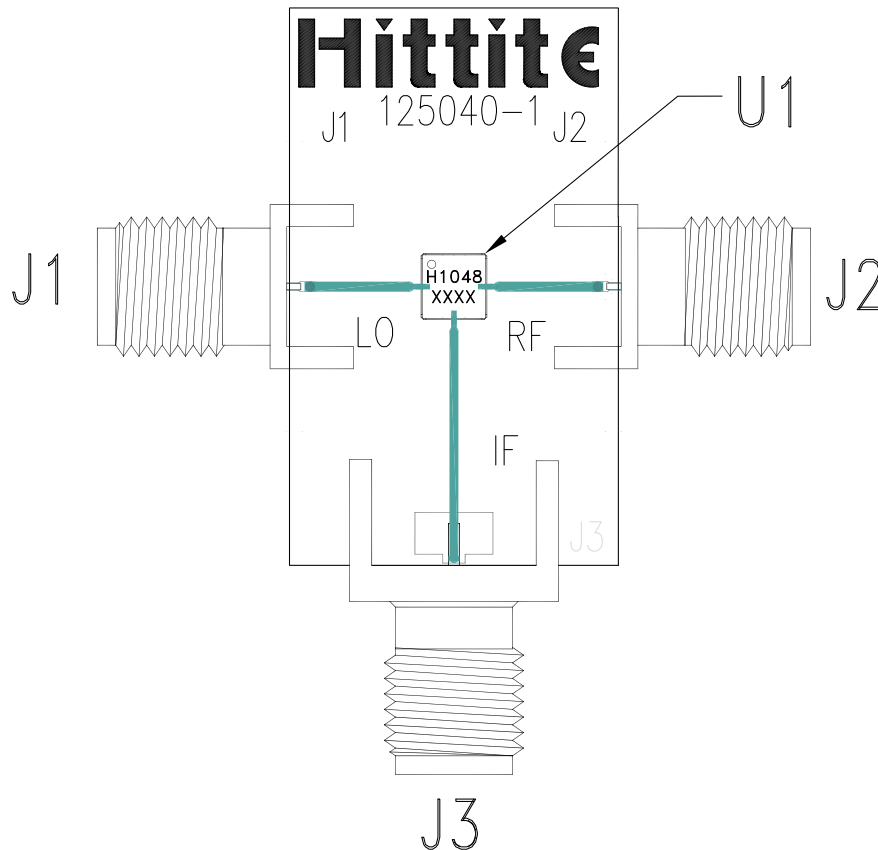
### Pin Descriptions

Pin Number	Function	Description	Interface Schematic
1, 3, 7, 9, 10, 12	GND	These pins and the exposed ground paddle must be connected to RF/DC ground.	
2	LO	This pin is matched to 50 Ohms.	
4, 6, 11	N/C	No connection required. These pins are not connected internally: However, all data shown herein was measured with these pins connected to ground.	
5	IF	This pin is DC coupled matched to 50 Ohms	
8	RF	This pin is matched to 50 Ohms	



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**Evaluation PCB**



**List of Materials for Evaluation PCB EVAL01-HMC1048LC3B [1]**

Item	Description
J1-J2	PCB Mount 2.9 mm K Connector, SRI
J3	PCB Mount SMA Connector
U1	HMC1048LC3B
PCB [2]	125040-1 Evaluation Board

[1] Reference this number when ordering complete evaluation PCB

[2] Circuit Board Material: Rogers 4350

The circuit board used in the application should use RF circuit design techniques. Signal lines should have 50 Ohm impedance while the package ground leads and exposed paddle should be connected directly to the ground plane similar to that shown. A sufficient number of via holes should be used to connect the top and bottom ground planes. The evaluation circuit board shown is available from Hittite upon request.